## 2024 IEEE Microelectronics Design and Test Symposium

## May 13 through May 15, 2024, at the Desmond Crowne Plaza located in Albany, New York

The 33rd IEEE Microelectronics Design & Test Symposium (MDTS, formerly known as NATW) provides an annual world forum for academia and industry. University faculty, student researchers, and industry engineers discuss latest advances in microelectronics, share their visions in modern microelectronic technologies, and foster academy-industry collaboration. The three-day symposium features keynote, invited talks, a panel and tutorial on the themes of **chiplets** and **hardware security**. Chiplets break large chip designs into smaller, ideally reusable, integrated circuits, and the Universal Chiplet Interconnect Express (UCIe) standard addresses the challenges of connecting chiplets in the package. Hardware security for chip designs covers a broad range of issues, from preventing reverse engineering to blocking takeovers and data theft or manipulation.

MDTS 2024 is sponsored by IEEE Schenectady Section and IEEE Region 1, and is supported by Advantest Corporation, AdamsIP, Cadence Design Systems, Green Mountain Semiconductor, IBM Corporation, and co-promotion with the SWTest Conference.

Monday, May 13
11:00 am - 8:00 pm Registration
12:00 pm - 1:00 pm Lunch
1:00 pm – 5:40 pm MDTS Sessions
1:00 pm – 1:10pm Welcome Address: Kelly Ockunzzi General Chair
Invited Speaker
1:10 pm – 1:15 pm Speaker Introduction
1:15 pm – 2:15 pm Speaker: Aydin Aysu
Title: Emerging Security Challenges at the Junction of AI and Hardware
Tutorial 2:15 - 5:40 PM : Chiplets and Hardware Security
2:15 pm – 2:20 pm Tutorialist Introduction:
2:20 pm – 3:20 pm Speaker: Martin Cochet
Title: Everything you always wanted to know about UCIe
3:20 pm – 3:30 pm Break
3:30 pm – 3:35 pm Tutorialist Introduction:
3:35 pm – 4:35 pm Speaker: Ramesh Karri
Title: Chiplets for Security and Security of Chiplets
4:35 pm – 4:40 pm Tutorialist Introduction:
4:40 pm – 5:25 pm Speaker: Paul Reuter
Title: IEEE P3405 Introduction, status update (Chiplet interconnect test and repair)
6:00 pm – 7:30 pm Opening Reception Dinner Buffet 5 Fort Orange
7:30 pm – 9:00 pm Panel: "Rise of the Chiplets" - Design, Test and Hardware Security
Panel Chair: Malinky Ghosh Panel Moderator: Eugene Atwood
Panelists
Ramesh Karri, Professor, Electrical and Computer Engineering, New York University
Martin Cochet, Senior Research Scientist, IBM Research
Nathaniel Cady, Associate Dean, University at Albany, The State University of New York
Paul Reuter, Senior Software Engineer, Siemens Digital Industries Software

Tuesday, May 14	
7:00 am - 6:00 pm Registration	
7:00 am - 8:30 am Breakfast	
8:30 am – 6:00 pm MDTS Sessions	
Session 1	
8:00 am - 8:05 am Welcome: Kelly Ockunzzi General Chair	
8:05 am – 8:10 am Program Introduction: Uma Srinivasan Program Chair	
Invited Speaker	
8:10 am – 8:15 am Invited Speaker Introduction:	
8:15 am – 9:10 am Invited Speaker: John Oakley	
Title: NIST-SRC Microelectronic and Advanced Packaging Roadmap	
Student Paper Session 1 & 2	
Session Chair:	
9:10 am - 9:30 am Paper 1.1: Title: Investigating Security on Networks on Chip with Ring Topology	
9:30 am - 9:50 am Paper 1.2: <b>Title:</b> Integrating ReRAM for Neuromorphic Computing: Real-time testing of packaged 64x64 1T1R cr arrays using a custom build microcontroller board	rossbar
9:50 am - 10:10 am Paper 1.3	
Title: Design of an OTA circuit for low voltage applications	
10:10 am – 10:20 am Break	
10:20 am - 10:40 am Paper 2.1	
Title: Harmonic Tag with Probe-Fed Patch Antennas	
10:40 am – 11:00 am: Paper 2.2 Title: Advancing Track Detection and Safety Using LabVIEW	
11:00 am – 11:05 am Invited Speaker Introduction	
11:05 am – 12:00 pm Invited Speaker: Selçuk Köse	
Title: Side-channel Leakage in Superconducting Electronics: Foe or Friend?	
12:00 pm - 1:00 pm Lunch	
Invited Speaker	
1:00 pm – 1:05 pm: Invited Speaker: Introduction	
1:05 pm – 2:00 pm: Invited Speaker: Gordon Harling <b>Title:</b> Platforms for creating and integrating chiplets	
Paper Session 3	
Session Chair:	
2:00 pm – 2:20 pm: Paper 3.1 <b>Title:</b> Within-Chip Bridged-Pattern Short Detection Using Spatially Distributed Kerf Test Structures in FinFET Technology	n 7nm
2:20 pm - 2:40 pm Paper 3.2: <b>Title:</b> On the Design of a 20 Channel Pin Parametric Measurement System for Post-Fabrication Testing	5
2:40 pm – 2:45 pm: Invited Speaker: Introduction	
2:45 pm – 3:40 pm: Invited Speaker: Gordon Harling	

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	Tour
3:40 pm – 5:40 pm: Alban	y Nanotech Tour
6:30 pm – 8:30 pm: Dinner	and Recognition Event: Best Student Paper Award
8:30 pm - 10:00 pm Netwo	vrking
	Wednesday, May 15
7:00 am – 11:00 am Registr	
7:00 am – 8:00 am Breakfa	
8:00 am - 12:00 pm MDTS	
8:00 am - 8:05 am Welcon	ne: Kelly Ockunzzi General Chair
	Invited Speaker
8:05 am – 8:10 am: Invited	
8:10 am – 9:05 am: Invited	
<b>Title:</b> "To break it, or fix i	t, that is the question"
	Paper Session 4
	Session Chair:
9:05 am – 9:25 am: Paper 4.	
Title: Machine Learning Inf	fused Software Testing for Mobile Device Development
CMOS 9:45 am – 10:05 am: Paper 4	Structures Bounded by Local Layout Density to Characterize Metal Gate Height
10:05 am - 10:15 am Break	
	Paper Session 5
	Session Chair:
10:15 am – 10:35 am Paper <b>Title:</b> Imaging Resistant Ma	- 5.1 ask Programmable Read Only Memory (ROM)
Title: Imaging Resistant Ma 10:35 am – 10:55 am Paper	ask Programmable Read Only Memory (ROM)
Title: Imaging Resistant Ma 10:35 am – 10:55 am Paper	ask Programmable Read Only Memory (ROM)
Title: Imaging Resistant Ma 10:35 am – 10:55 am Paper Title: High-Speed Receiver 10:55 am – 11:00 am: Invit	Ask Programmable Read Only Memory (ROM) 5.2 Transient Modeling with Generative Adversarial Networks Invited Speaker ed Speaker: Introduction
<b>Title:</b> Imaging Resistant Ma 10:35 am – 10:55 am Paper <b>Title:</b> High-Speed Receiver 10:55 am – 11:00 am: Invit 11:00 am – 11:50 am: Invit	ask Programmable Read Only Memory (ROM) : 5.2 : Transient Modeling with Generative Adversarial Networks Invited Speaker ed Speaker: Introduction ed Speaker: Xiaolin Xu
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Title: Imaging Resistant Ma 10:35 am – 10:55 am Paper Title: High-Speed Receiver 10:55 am – 11:00 am: Invit 11:00 am – 11:50 am: Invit Title: On the Dark Side of	ask Programmable Read Only Memory (ROM) : 5.2 : Transient Modeling with Generative Adversarial Networks Invited Speaker ed Speaker: Introduction ed Speaker: Xiaolin Xu

Please complete our survey online:

Microelectronic Design and Test Symposium 2024 Survey

**MDTS 2024**